onsemi

Octal D-Type Latch / 3-STATE Octal D-Type Flip-Flop

MM74HCT573/MM74HCT574

General Description

The MM74HCT573 octal D-type latches and MM74HCT574 octal D-type flip-flop advanced silicon-gate CMOS technology, which provides the inherent benefits of low power consumption and wide power supply range, but are LS-TTL input and output characteristic and pin-out compatible. The 3-STATE outputs are capable of driving 15 LS-TTL loads. All inputs are protected from damage due to static discharge by internal diodes to V_{CC} and ground.

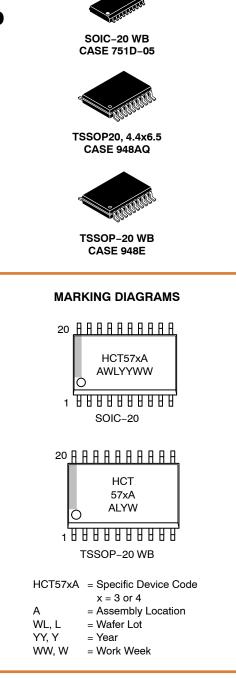
When the MM74HCT573 Latch Enable input is HIGH, the Q outputs will follow the D inputs. When the Latch Enable goes LOW, data at the D inputs will be retained at the outputs until Latch Enable returns HIGH again. When a high logic level is applied to the Output Control input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The MM74HCT574 are positive edge triggered flip-flops. Data at the D inputs, meeting the setup and hold time requirements, are transferred to the Q outputs on positive going transitions of the Clock (CK) input. When a high logic level is applied to the Output Control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Features

- TTL Input Characteristic Compatible
- Typical Propagation Delay: 17 ns
- Low Input Current: 1 µA Maximum
- Low Quiescent Current: 160 µA Maximum
- Compatible with Bus-oriented Systems
- Output Drive Capability: 15 LS-TTL Loads
- These are Pb-Free Devices

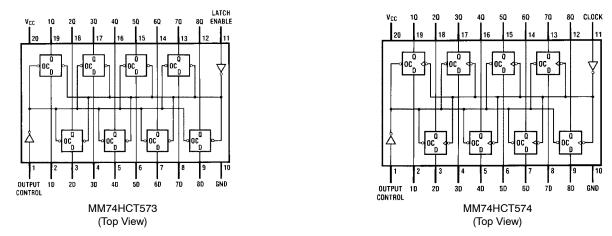


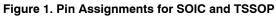
ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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Connection Diagrams





Truth Tables

MM74HCT573

Output Control	LE	Data	373 Output
L	Н	Н	Н
L	Н	L	L
L	L	Х	Q ₀
Н	Х	Х	Z

NOTES: H = HIGH Level

L = LOW Level

Q0 = Level of output before steady-state input conditions were established.

Z = High Impedance State

MM74HCT574

Output Control	Clock	Data	374 Output
L	\uparrow	Н	Н
L	\uparrow	L	L
L	L	Х	Q ₀
Н	Х	Х	Z

NOTES: H = HIGH Level

L = LOW Level

 Q_0 = The level of the output before steady state input conditions were established.

= Don't Care Х

Ζ = High Impedance State ↑

= Transition from LOW-to-HIGH

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol		Parameter	Rating
V _{CC}	Supply Voltage		–0.5 to +7.0 V
V _{IN}	DC Input Voltage	DC Input Voltage	
V _{OUT}	DC Output Voltage		–0.5 to V _{CC} + 0.5 V
I _{IK} , I _{OK}	Clamp Diode Current		±20 mA
I _{OUT}	DC Output Current, per Pin		±35 mA
I _{CC}	DC V _{CC} or GND Current, per Pin		±70 mA
T _{STG}	Storage Temperature Range		–65°C to +150°C
PD	Power Dissipation	S.O. Package only	500 mW
ΤL	Lead Temperature (Soldering 10 S	Seconds)	260°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range	-55	+125	°C
t _r , t _f	Input Rise or Fall Times		500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

			Τ _Α	, = 25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	;
Symbol	Parameter	Conditions	Тур	Gi	uaranteed Lin	nits	Unit
V _{IH}	Minimum HIGH Level Input Voltage		-	2.0	2.0	2.0	V
V _{IL}	Maximum LOW Level Input Voltage		-	0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} = 20 \ \mu A$	V _{CC}	V _{CC} – 0.1	V _{CC} – 0.1	V _{CC} – 0.1	V
			4.2	3.98	3.84	3.7	V
		$\label{eq:VIN} \begin{split} V_{IN} &= V_{IH} \text{ or } V_{IL} \\ \left I_{OUT} \right &= 7.2 \text{ mA}, V_{CC} = 5.5 \text{ V} \end{split}$	5.7	4.98	4.84	4.7	V
V _{OL}	Maximum LOW Level Voltage	V _{IN} = V _{IH} or V _{IL} I _{OUT} = 20 μA	0	0.1	0.1	0.1	V
			0.2	0.26	0.33	0.4	V
		$\label{eq:VIN} \begin{split} V_{\text{IN}} &= V_{\text{IH}} \text{ or } V_{\text{IL}} \\ \left I_{\text{OUT}} \right &= 7.2 \text{ mA}, \ V_{\text{CC}} = 5.5 \text{ V} \end{split}$	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}	-	±0.1	±1.0	±1.0	μA
I _{OZ}	Maximum 3-STATE Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, Enable = V_{IH} or V_{IL}	-	±0.5	±5.0	±10	μA
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \ \mu A$	-	8.0	80	160	μA
		V _{IN} = 2.4 V or 0.5 V (Note 2)	-	1.5	1.8	2.0	mA

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 V \pm 10%, unless otherwise specified)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Measured per pin. All others tied to V_{CC} or ground.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT573: V_{CC} = 5.0 V, T_A = 25°C, $t_r = t_f = 6$ ns, unless otherwise specified)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay Data to Output	C _L = 45 pF	17	27	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay Latch Enable to Output	C _L = 45 pF	16	27	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	$C_L = 45 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	21	30	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	C _L = 5 pF R _L = 1 kΩ	14	23	ns
t _W	Minimum Clock Pulse Width		-	15	ns
t _S	Minimum Setup Time Data to Clock		-	5	ns
t _H	Minimum Hold Time Clock to Data		-	12	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT573: V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, unless otherwise specified)

			T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits.	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay Data to Output	C _L = 50 pF	18	30	38	45	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay Latch Enable to Output	C _L = 50 pF	17	30	44	53	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	22	30	38	45	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	15	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	C _L = 50 pF	6	12	15	18	ns
t _W	Minimum Clock Pulse Width		-	15	20	24	ns
t _S	Minimum Setup Time Data to Clock		3	5	6	8	ns
t _H	Minimum Hold Time Clock to Data		4	12	15	18	ns
C _{IN}	Maximum Input Capacitance		-	10	10	10	pF
C _{OUT}	Maximum Output Capacitance		-	20	20	20	pF
C _{PD}	Power Dissipation Capacitance (Note 3)	OC = V _{CC}	-	5	-	-	pF
		OC = GND	-	52	-	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC}^2 f + I_{CC}$.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT574: V_{CC} = 5.0 V, T_A = 25°C, t_r = t_f = 6 ns)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
f _{MAX}	Maximum Clock Frequency		60	33	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay to Output	C _L = 45 pF	17	27	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	$C_L = 45 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	19	28	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	$C_L = 45 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	14	25	ns
t _W	Minimum Clock Pulse Width		-	15	ns
t _S	Minimum Setup Time Data to Clock		-	12	ns
t _H	Minimum Hold Time Clock to Data		-	5	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT574: V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, unless otherwise specified)

			T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits.	Unit
f _{MAX}	Maximum Clock Frequency		-	33	28	23	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay Clock to Output	C _L = 50 pF	18	30	38	45	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	22	30	38	45	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	15	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	C _L = 50 pF	6	12	15	18	ns
t _W	Minimum Clock Pulse Width		-	15	20	24	ns
t _S	Minimum Setup Time Data to Clock		6	12	15	18	ns
t _H	Minimum Hold Time Clock to Data		1	5	6	8	ns
C _{IN}	Maximum Input Capacitance		-	10	10	10	pF
C _{OUT}	Maximum Output Capacitance		-	20	20	20	pF
C _{PD}	Power Dissipation Capacitance (Note 4)	OC = V _{CC}	5	-	-	-	pF
		OC = GND	58	-	-	-	pF

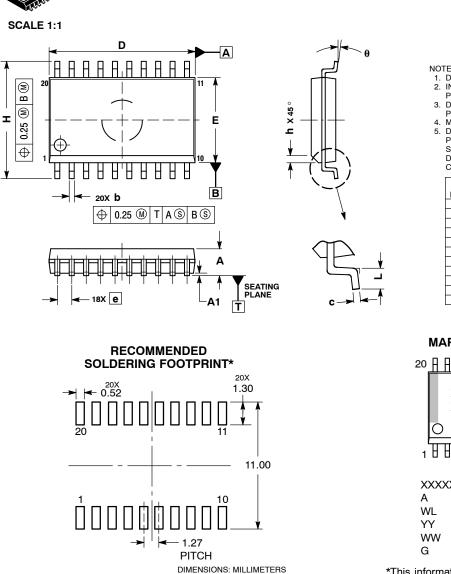
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC}^2 f + I_{CC}$.

ORDERING INFORMATION

Part Number	Package	Shipping [†]
MM74HCT573WMX	SOIC-20 WB, Case 751D-05 (Pb-Free and Halide-Free)	1000 Units / Tape & Reel
MM74HCT573MTC	TSSOP-20 WB, Case 948E	75 Units / Tube
MM74HCT573MTCX	(Pb-Free)	2500 Units / Tape & Reel
MM74HCT574WM	SOIC-20 WB, Case 751D-05	38 Units / Tube
MM74HCT574WMX	(Pb-Free and Halide-Free)	1000 Units / Tape & Reel
MM74HCT574MTC	TSSOP-20 WB, Case 948E (Pb-Free)	75 Units / Tube
MM74HCT574MTCX	TSSOP20, Case 948AQ-01 (Pb-Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 22 APR 2015

DUSEM

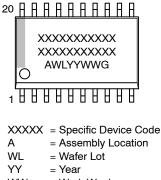
NOTES:

SOIC-20 WB CASE 751D-05 ISSUE H

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	MILLIMETERS			
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10 0.25				
b	0.35 0.49				
C	0.23	0.32			
D	12.65	12.95			
Е	7.40	7.60			
е	1.27	BSC			
Н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
θ	0 °	7 °			

GENERIC **MARKING DIAGRAM***



= Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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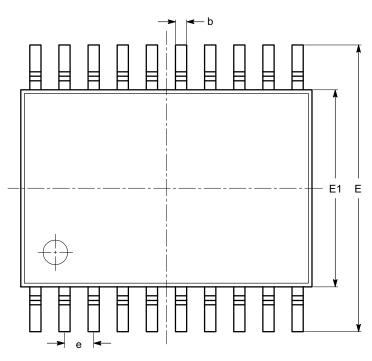
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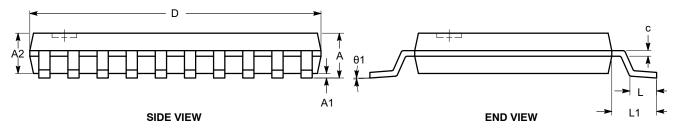
TSSOP20, 4.4x6.5 CASE 948AQ-01 ISSUE A

DATE 19 MAR 2009



SYMBOL	MIN	NOM	MAX
А			1.20
A1	0.05		0.15
A2	0.80		1.05
b	0.19		0.30
с	0.09		0.20
D	6.40	6.50	6.60
E	6.30	6.40	6.50
E1	4.30	4.40	4.50
е		0.65 BSC	
L	0.45	0.60	0.75
L1		1.00 REF	
θ	0°		8°

TOP VIEW



Notes:

All dimensions are in millimeters. Angles in degrees.
Complies with JEDEC MO-153.

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